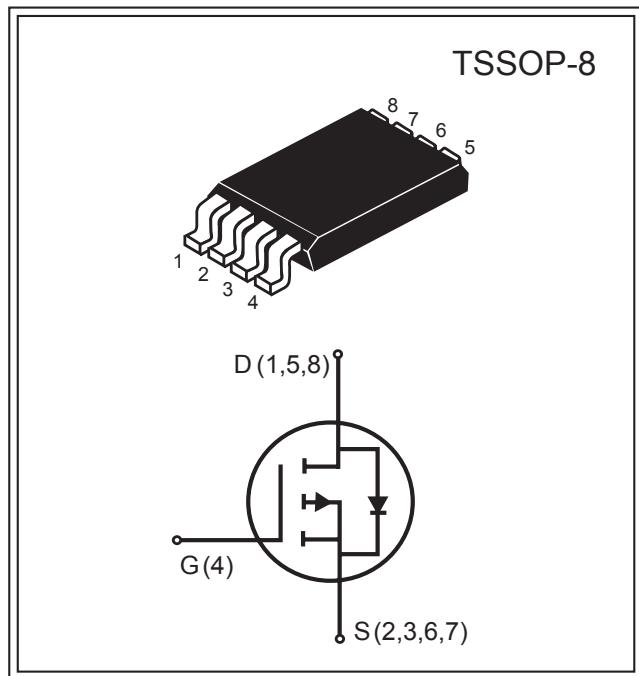


Product Summary		
V <sub>DS</sub> (V)	I <sub>D</sub> (A)	R <sub>DS(ON)</sub> (mΩ) Max
-20V	-5.5A	32 @ V <sub>GS</sub> = -4.5V
		50 @ V <sub>GS</sub> = -2.5V
		98 @ V <sub>GS</sub> = -1.8V

## FEATURES

- ◆ Super high density cell design for low R<sub>DS(ON)</sub>.
- ◆ Rugged and reliable.
- ◆ TSSOP-8 package.
- ◆ Pb free.



## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Drain Current-Continuous @ T <sub>J</sub> = 125°C -Pulsed <sup>b</sup>	I <sub>D</sub>	-5.5	A
Drain-Source Diode Forward Current <sup>a</sup>	I <sub>S</sub>	-1.5	A
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	1.5	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

## THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient <sup>a</sup>	R <sub>θ JA</sub>	82	°C/W
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South Sea Semiconductor reserves the right to make changes to improve reliability or manufacturability without advance notice.

South Sea Semiconductor, February 2008 (Rev 1.0)



South Sea Semiconductor

SSG9423

P-Channel Electrical Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250 \mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=-16\text{V}, V_{\text{GS}}=0\text{V}$			-1	$\mu\text{A}$
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 8\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250 \mu\text{A}$	-0.4		-1.0	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-5.0\text{A}$		23	32	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-3.0\text{A}$		38	50	
		$V_{\text{GS}}=-1.8\text{V}, I_{\text{D}}=-2.0\text{A}$			98	
On-State Drain Current	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}}=-5\text{V}, V_{\text{GS}}=-4.5\text{V}$	-10			A
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-4\text{A}$		12		S
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=-6\text{V}$		1100		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$	$V_{\text{GS}}=0\text{V}$		240		
Reverse Transfer Capacitance	$C_{\text{rss}}$	$f=1.0\text{MHz}$		170		
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}}=-6\text{V},$		25		$\text{ns}$
Rise Time	$t_r$	$I_{\text{D}}=-1\text{A},$		45		
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$	$V_{\text{GEN}}=-4.5\text{V},$		80		
Fall Time	$t_f$	$R_{\text{GEN}}=6\Omega,$		60		
Total Gate Charge	$Q_g$	$V_{\text{DS}}=-6\text{V},$		13		$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$	$I_{\text{D}}=-3.4\text{A},$		2		
Gate-Drain Charge	$Q_{\text{gd}}$	$V_{\text{GS}}=-4.5\text{V}$		3.8		
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-1.7\text{A}$			-1.2	V

## Notes :

- a. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
- b. Pulse Test : Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- c. Guaranteed by design, not subject to production testing.

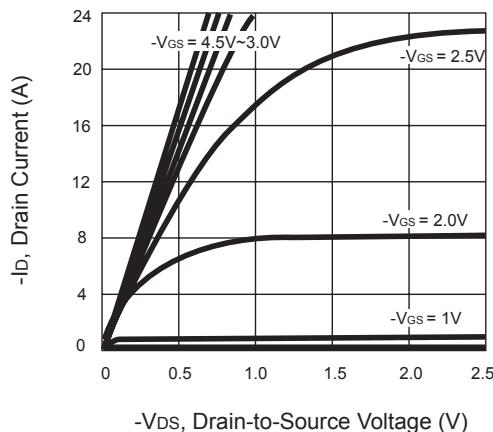


Figure 1. Output Characteristics

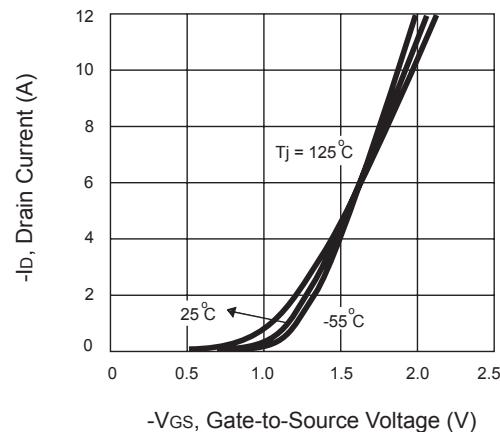


Figure 2. Transfer Characteristics

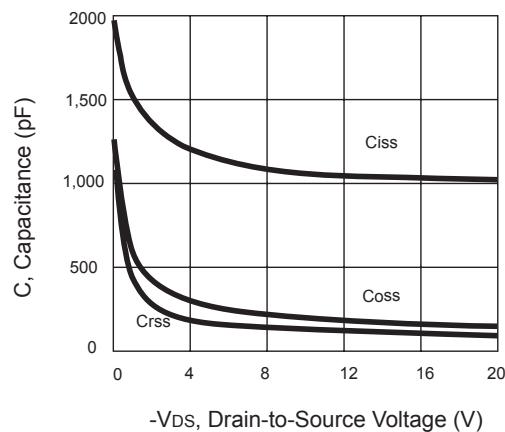


Figure 3. Capacitance

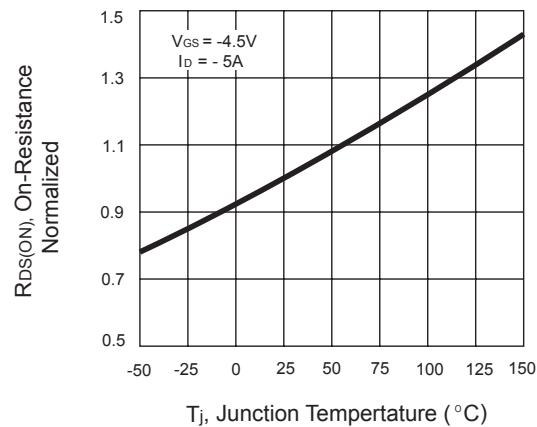


Figure 4. On-Resistance Variation with Temperature

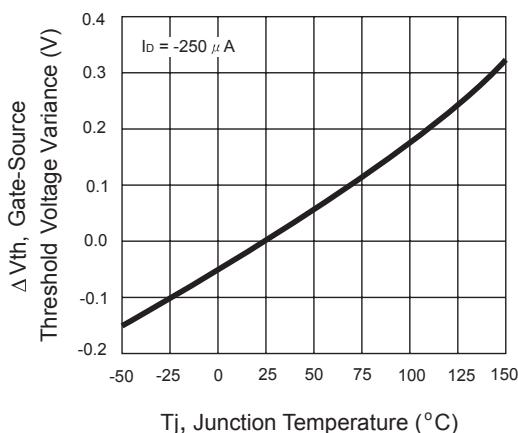


Figure 5. Gate Threshold Variation with Temperature

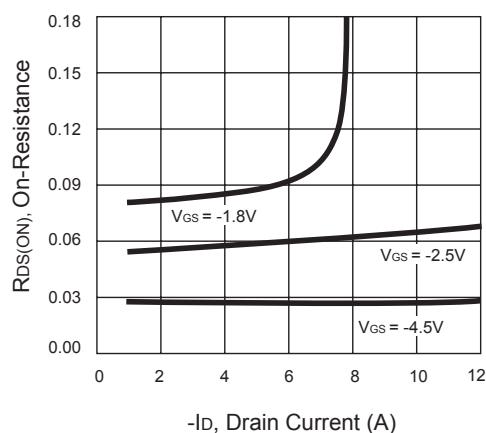


Figure 6. On-Resistance Variation with Drain Current

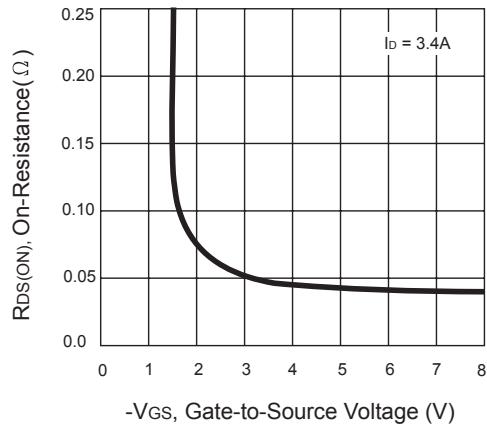


Figure 7. On-Resistance Variation with Gate-to-Source Voltage

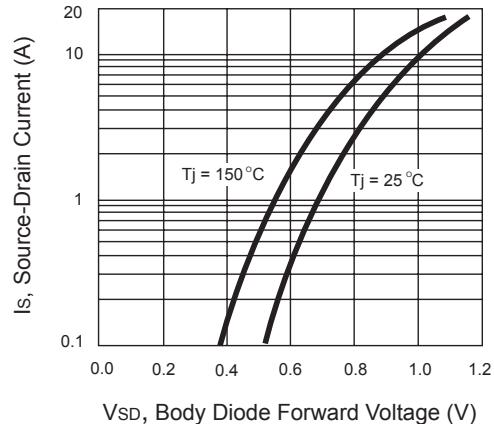


Figure 8. Body Diode Forward Voltage Variation with Source Current

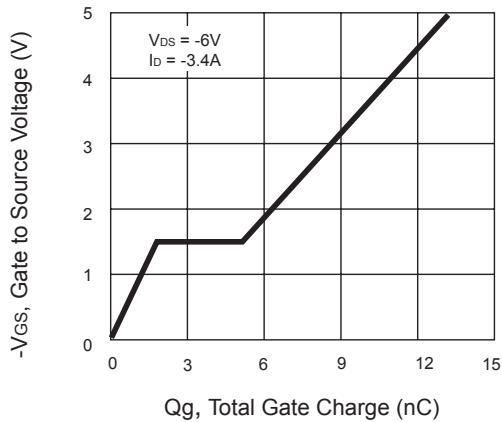


Figure 9. Gate Charge

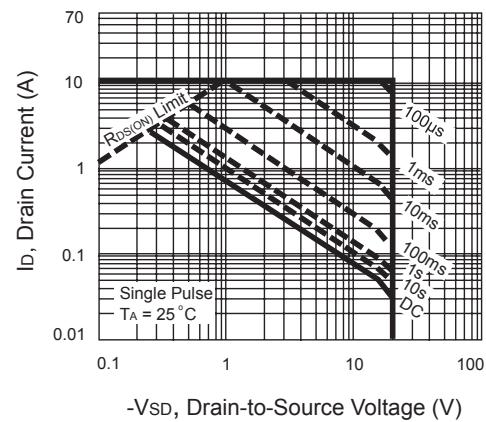


Figure 10. Maximum Safe Operating Area

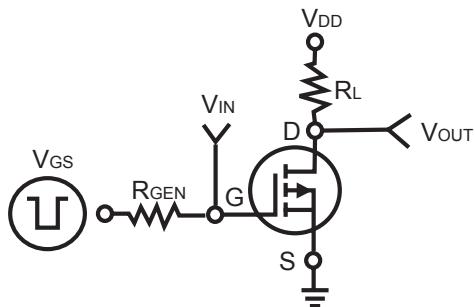


Figure 11. Switching Test Circuit

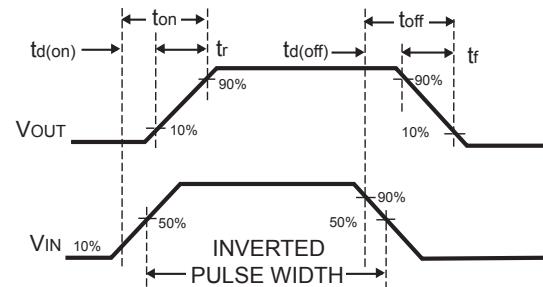


Figure 12. Switching Waveforms

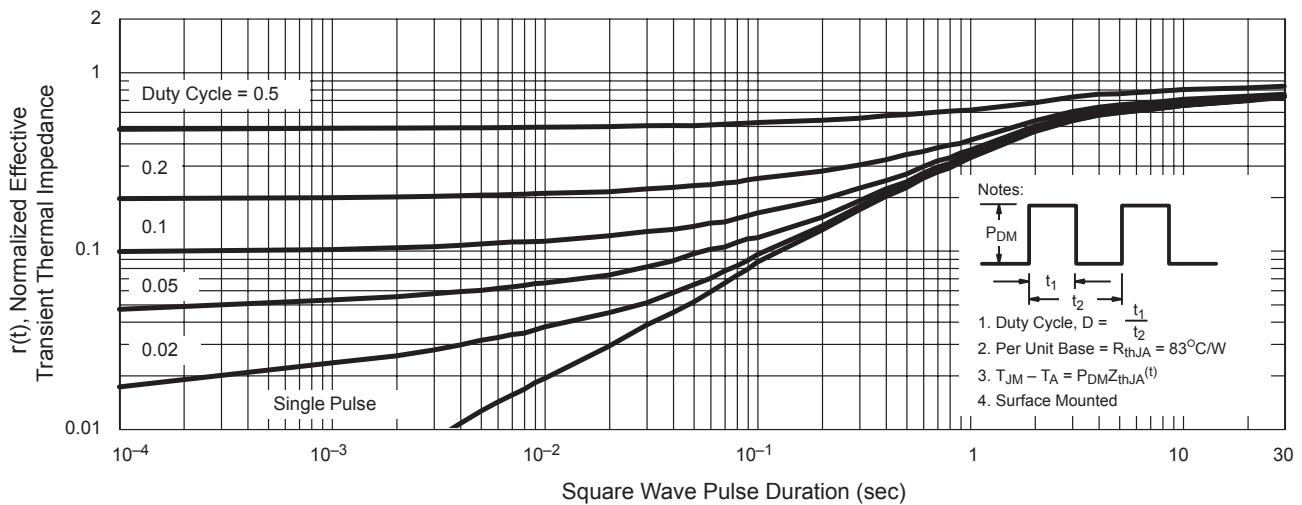


Figure 13. Normalized Thermal Transient Impedance Curve